Sup*IR*Buck™

USER GUIDE FOR IR3821 EVALUATION BOARD

DESCRIPTION

The IR3821 is a synchronous buck converter, providing a compact, high performance and flexible solution in a small 5mmx6mm Power QFN package.

Key features offered by the IR3821 include programmable soft-start ramp, precision 0.6V reference voltage, programmable Power Good, thermal protection, fixed 600kHz switching frequency requiring no external component, input under-voltage lockout for proper start-up, and pre-bias start-up.

An output over-current protection function is implemented by sensing the voltage developed across the on-resistance of the synchronous rectifier MOSFET for optimum cost and performance.

This user guide contains the schematic and bill of materials for the IR3821 evaluation board. The guide describes operation and use of the evaluation board itself. Detailed application information for IR3821 is available in the IR3821 data sheet.

BOARD FEATURES

- V_{in} = +12V (13.2V Max)
- V_{out} = +1.8V @ 0- 7A
- L=1.0uH
- C_{in}=3x10uF (ceramic 1206) + 330uF (electrolytic)
- C_{out}=6x22uF (ceramic 0805)

CONNECTIONS and OPERATING INSTRUCTIONS

A well regulated +12V input supply should be connected to VIN+ and VIN-. A maximum 7A load should be connected to VOUT+ and VOUT-. The connection diagram is shown in Fig. 1 and inputs and outputs of the board are listed in Table I.

IR3821 has two input supplies, one for biasing (Vcc) and the other as input voltage (Vin). These inputs are connected on the board with a zero ohm resistor (R15). Separate supplies can be applied to these inputs. *Vcc input cannot be connected unless R15 is removed.* Vcc input should be a well regulated 5V-12V supply and it would be connected to Vcc+ and Vcc-.

Table I. Connections

Connection	Signal Name
VIN+	V_{in} (+12V)
VIN-	Ground of V_{in}
Vcc+	Optional Vcc input
Vcc-	Ground for Optional Vcc input
VOUT-	Ground of V_{out}
VOUT+	V_{out} (+1.8V)
P_Good	Power Good Signal

LAYOUT

The PCB is a 4-layer board. All of layers are 2Oz. copper. The IR3821 SupIRBuck and all of the passive components are mounted on the top side of the board.

Power supply decoupling capacitors, the charge-pump capacitor and feedback components are located close to IR3821. The feedback resistors are connected to the output voltage at the point of regulation and are located close to SupIRBuck.

To improve efficiency, the circuit board is designed to minimize the length of the on-board power ground current path.

Connection Diagram

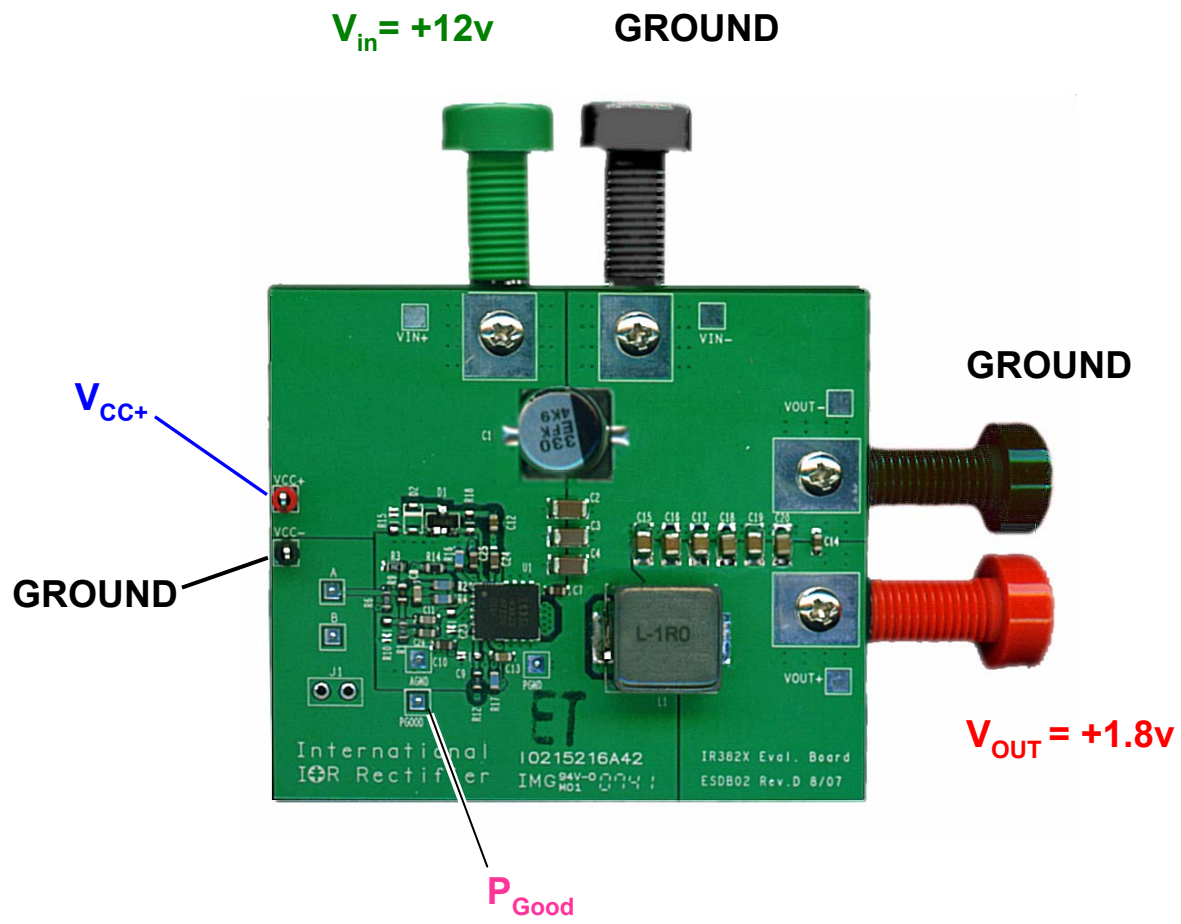


Fig. 1: Connection diagram of IR3821 evaluation board

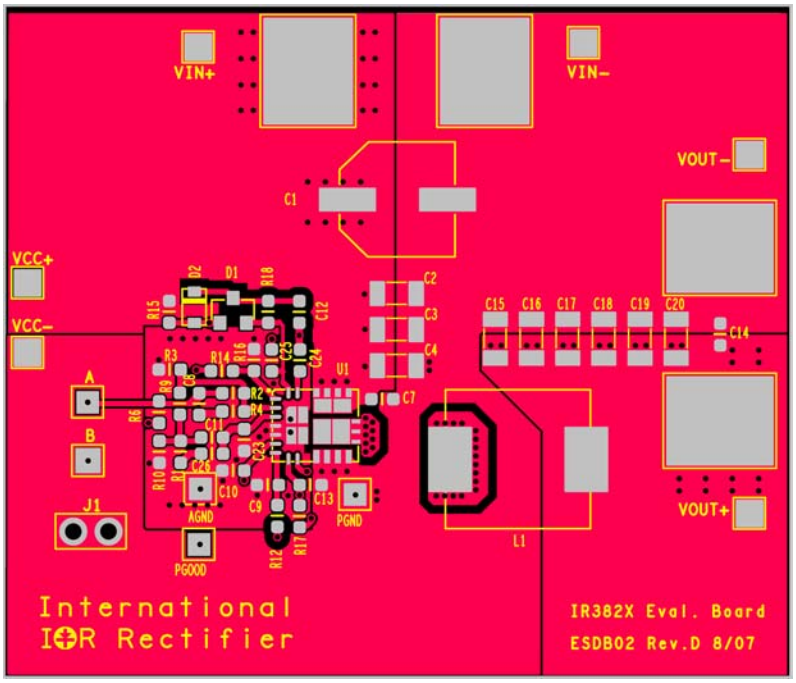


Fig. 2: Board layout, top overlay

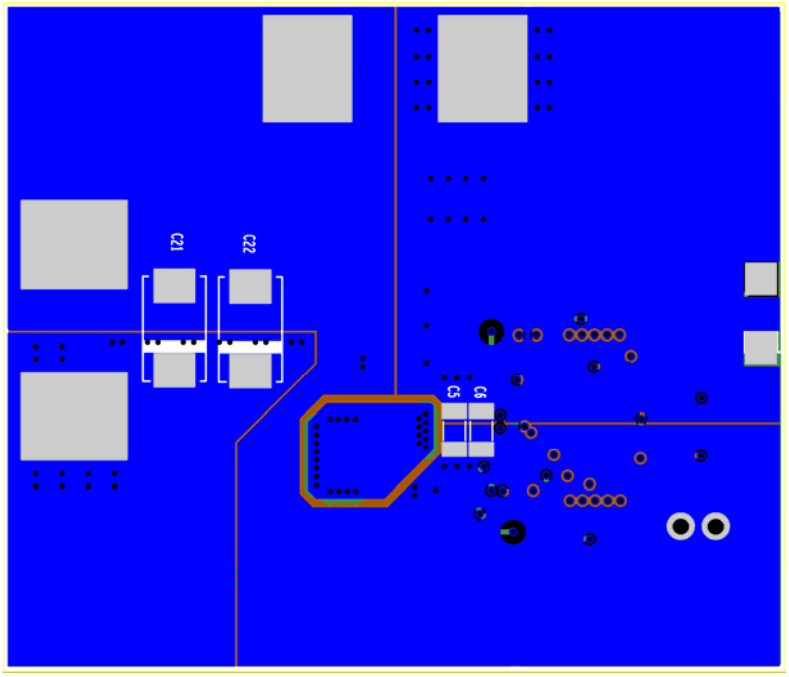


Fig. 3: Board layout, bottom overlay (rear view)

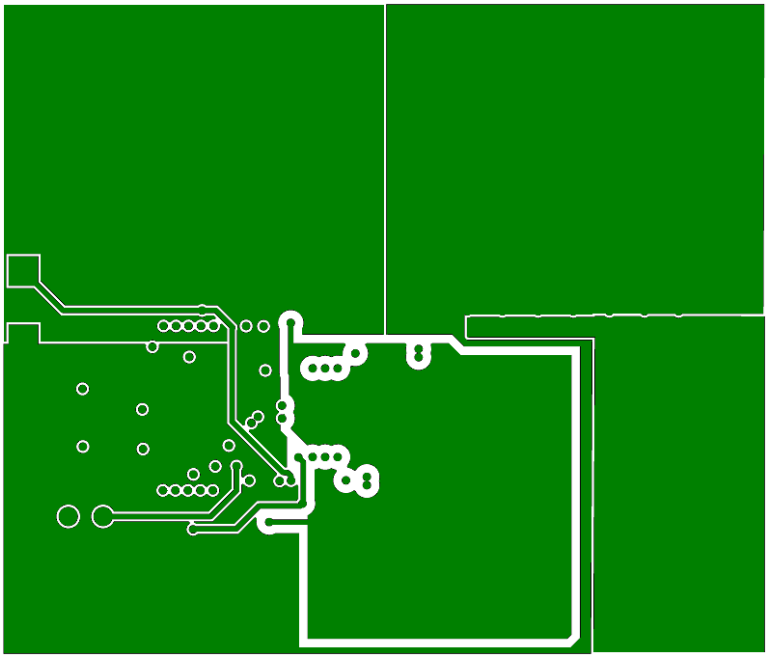


Fig. 4: Board layout, mid-layer I

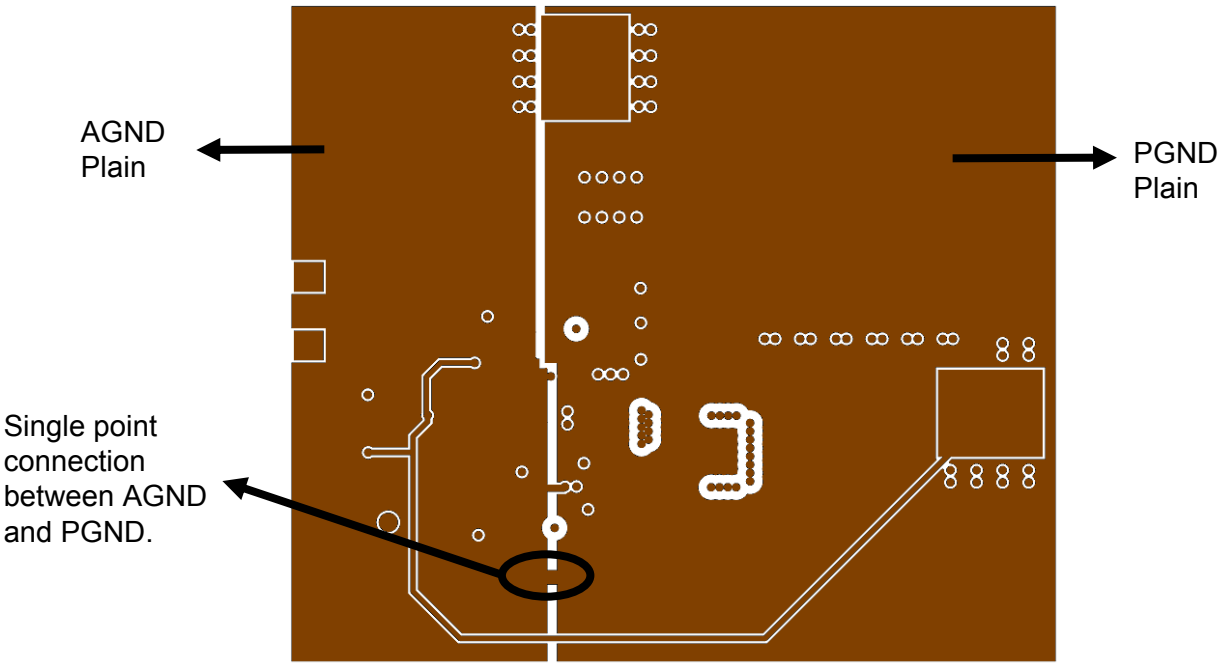


Fig. 5: Board layout, mid-layer II

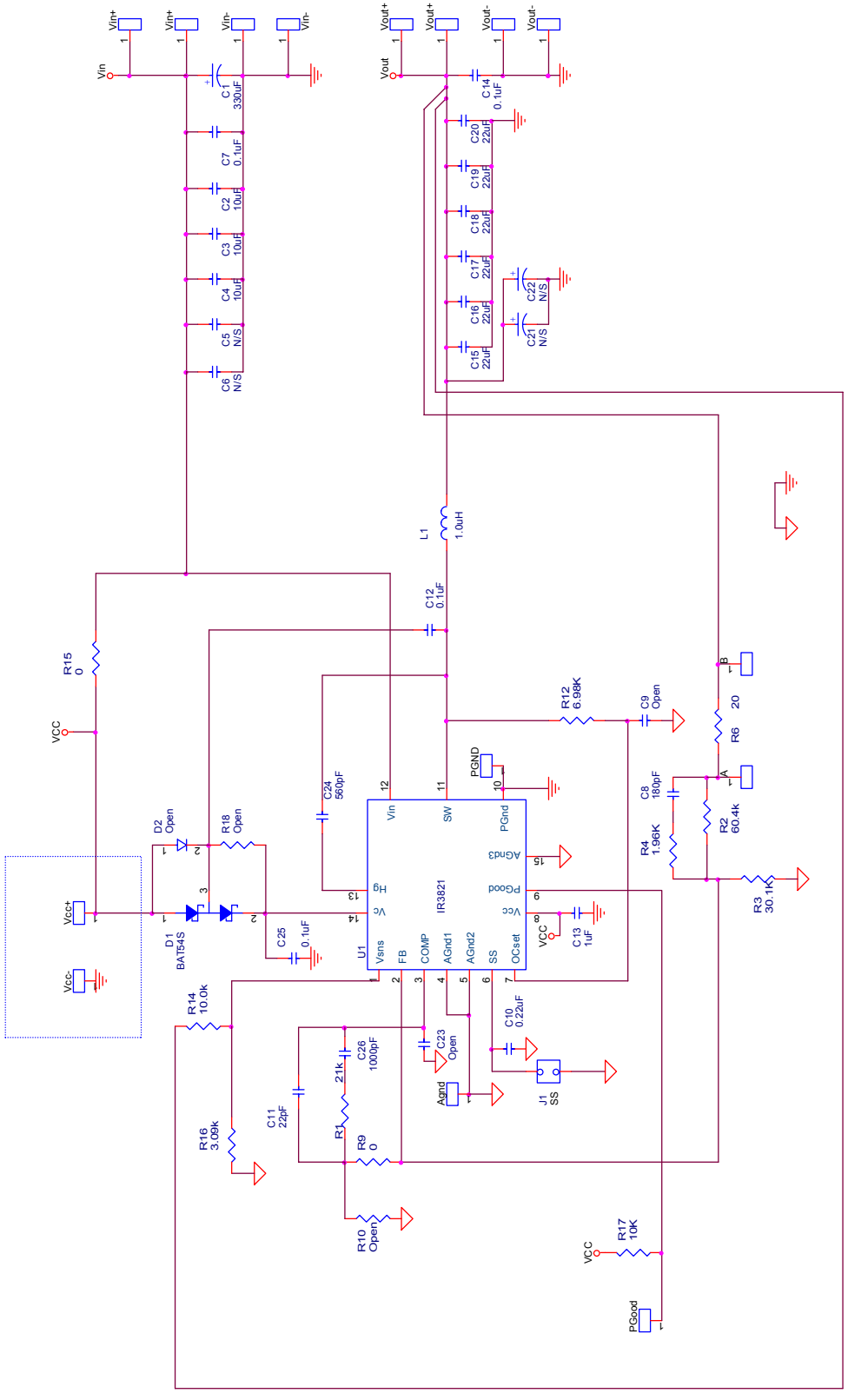


Fig. 6: Schematic of the IR3821 evaluation board

Bill of Materials

Item	Quantity	Designator	Value	Description	Size	Manufacturer	Mfr. Part Number
1	1	C1	330uF	SMD Electrolytic, 25V, 20%	SMD	Panasonic	EEV-FK1E331P
2	3	C2 C3 C4	10uF	Ceramic, 16V, X7R, 10%	1206	Panasonic	ECJ-3YX1C106K
3	4	C7 C12 C14 C25	0.1uF	Ceramic, 50V, X7R, 10%	0603	Panasonic	ECJ-1VB1H104K
4	1	C10	0.22uF	Ceramic, 10V, X5R, 10%	0603	Panasonic	ECJ-1VB1A224K
5	1	C8	180pF	Ceramic, 50V, NPO, 5%	0603	Murata	GRM1885C1H181JA01
6	1	C11	22pF	Ceramic, 50V, NPO, 5%	0603	Murata	GRM1885C1H220JA01
7	1	C13	1uF	Ceramic, 16V, X5R, 10%	0603	Panasonic	ECJ-1VB1C105K
8	6	C15 C16 C17 C18 C19 C20	22uF	Ceramic, 6.3V, X5R, 20%	0805	Panasonic	ECJ-2FB0J226M
9	1	C24	560pF	Ceramic, 50V, NPO, 5%	0603	Murata	GRM1885C1H561JA01
10	1	C26	1000pF	Ceramic, 50V, NPO, 5%	0603	Murata	GRM1885C1H102JA01
11	1	D1	BAT54S	Diode Schottky ,40V, 200mA	SOT-23	Fairchild	BAT54S
12	1	L1	1.0uH	SMT Inductor, 2.3mOhm, 20%	11.5x 10mm	Delta	MPL105-1R0
13	1	R1	21.0K	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW060321K0FKEA
14	1	R3	30.1K	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW060330K1FKEA
15	1	R2	60.4K	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW060360K4FKEA
16	1	R4	1.96K	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW06031K96FKEA
17	1	R6	20	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW060320R0FKEA
18	2	R9 R15	0	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW06030000Z0EA
19	1	R12	6.98K	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW06036K98FKEA
20	2	R14, R17	10K	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW060310K0FKEA
21	1	R16	3.09K	Thick film, 1/10W, 1%	0603	Vishey/Dale	CRCW06033K09FKEA
22	1	U1	IR3821	600kHz, 7A, SupIRBuck Module	5x6mm	International Rectifier	IR3821
23	2	-	-	Banana Jack, Insulated Solder Terminal, Black	-	Johnson Components	105-0853-001
24	1	-	-	Banana Jack- Insulated Solder Terminal, Red	-	Johnson Components	105-0852-001
25	1	-	-	Banana Jack- Insulated Solder Terminal, Green	-	Johnson Components	105-0854-001

TYPICAL OPERATING WAVEFORMS

Vin=Vcc=12.0V, Vo=1.8V, Io=0-7A, Room Temperature, No Air Flow

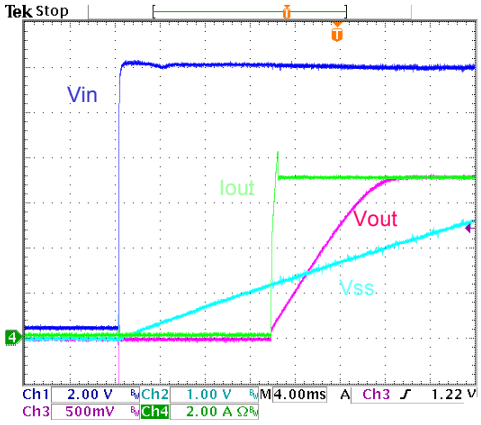


Fig. 7: Start up at 7A Load
Ch_1:V_{in}, Ch_2:V_{SS}, Ch_3:V_{out}, Ch_4:I_{out}

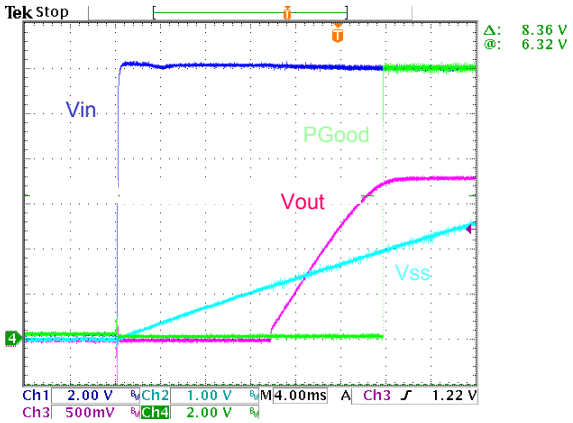


Fig. 8: Start up at 7A Load,
Ch_1:V_{in}, Ch_2:V_{SS}, Ch_3:V_{out}, Ch_4:V_{PGood}

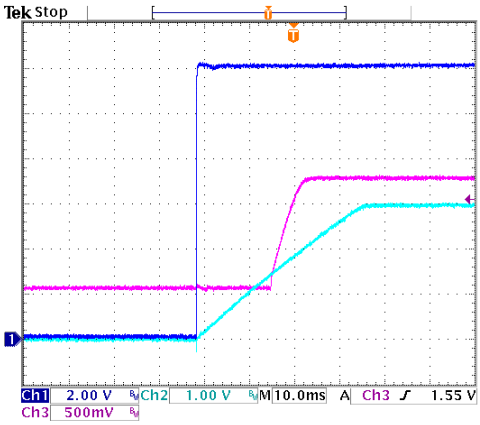


Fig. 9: Pre-Bias Start up, 0A Load
Ch_1:V_{in}, Ch_2:V_{SS}, Ch_3:V_{out}

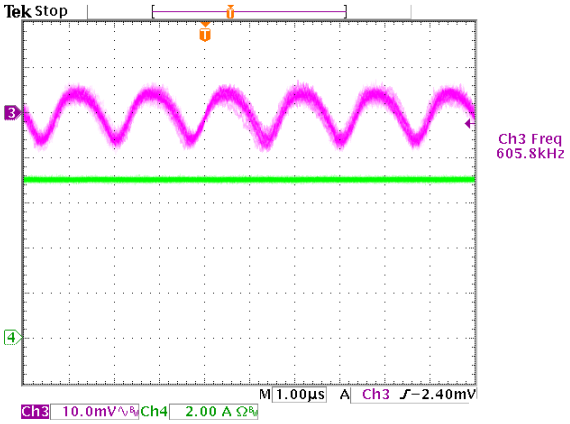


Fig. 10: Output Voltage Ripple, 7A load
Ch_3: V_{out} , Ch_4: I_{out}

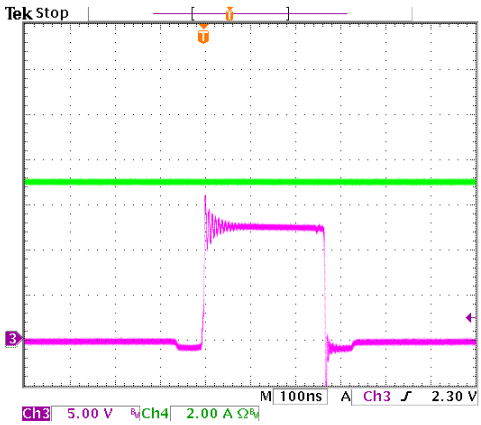


Fig. 11: Inductor node at 7A load
Ch_1:LX, Ch_4:I_{out}

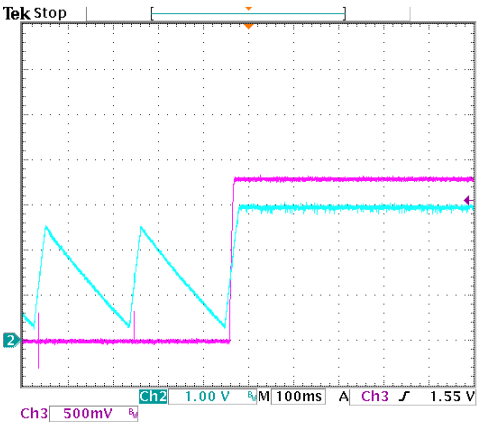
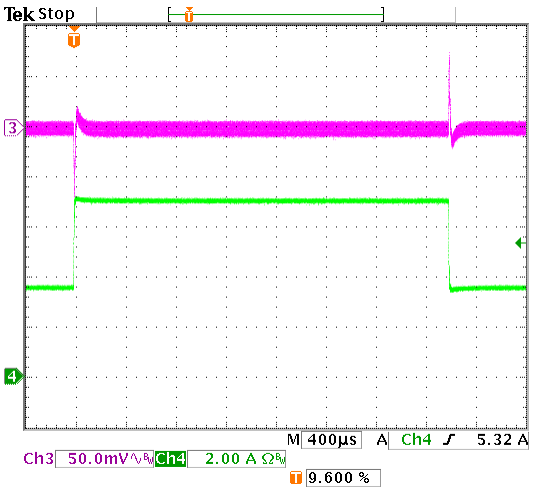
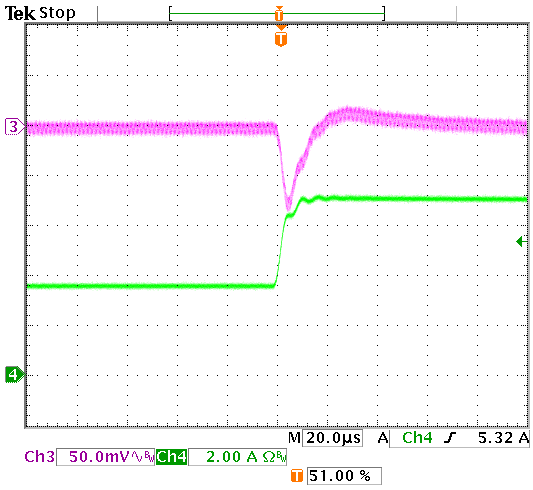


Fig. 12: Short (Hiccup) Recovery
Ch_2:V_{SS} , Ch_3:V_{out}

TYPICAL OPERATING WAVEFORMS
Vin=Vcc=12V, Vo=1.8V, Io=3.5A-7A, Room Temperature, No Air Flow





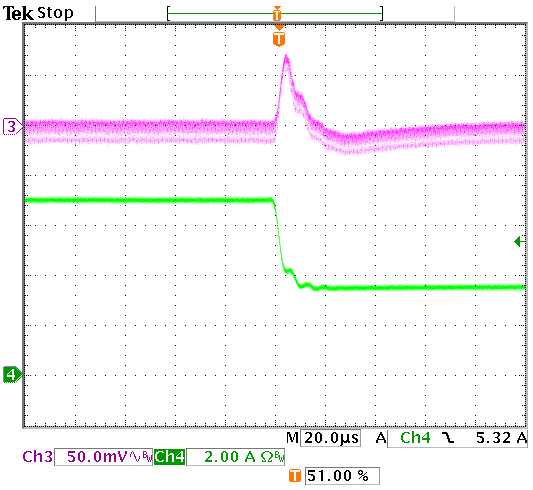


Fig. 13: Transient Response, 3.5A to 7A step
Ch_3:V_{out}, Ch_4:I_{out}

TYPICAL OPERATING WAVEFORMS
Vin=Vcc=12V, Vo=1.8V, Io=7A, Room Temperature, No Air Flow

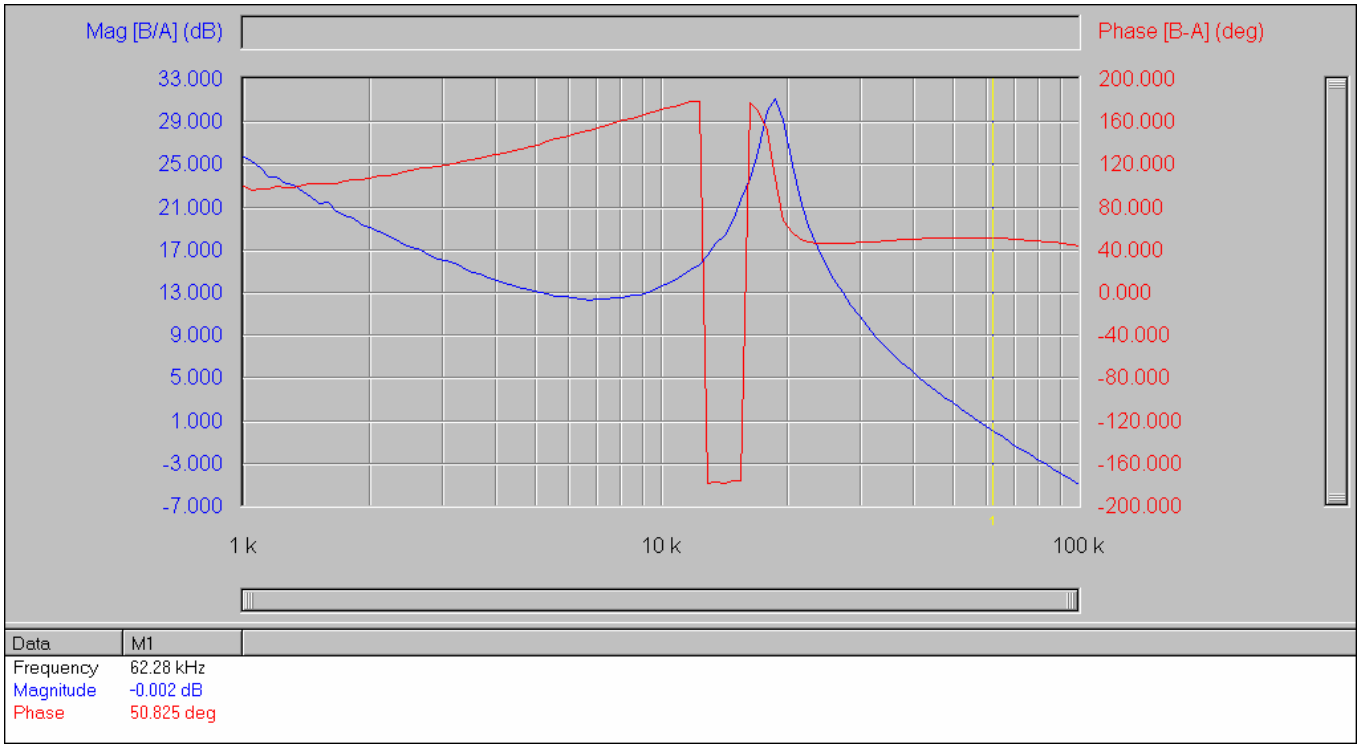


Fig. 14: Bode Plot at 7A load shows a bandwidth of 62 kHz and phase margin of 51 degrees

TYPICAL OPERATING WAVEFORMS
Vin=12V, Vo=1.8V, Io=0-7A, Room Temperature, No Air Flow

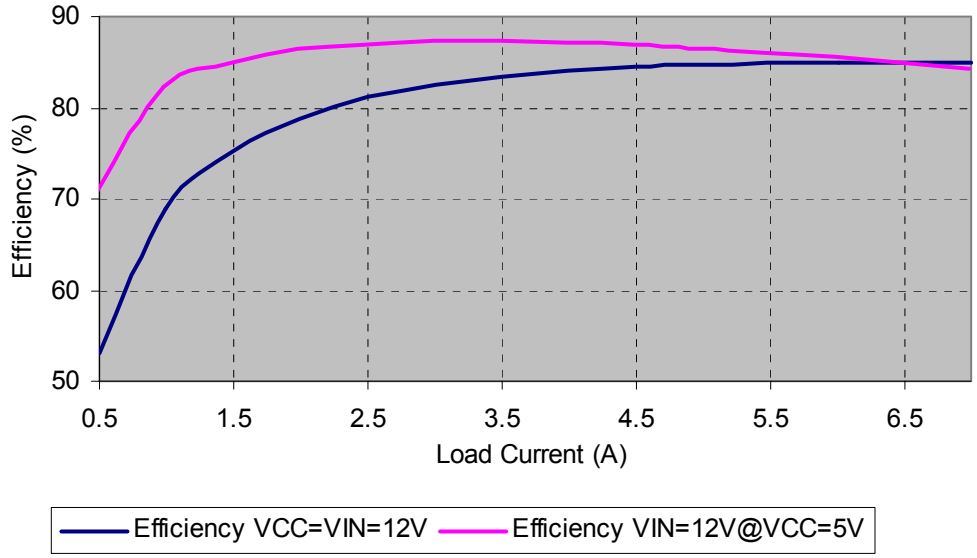


Fig.15: Efficiency versus load current

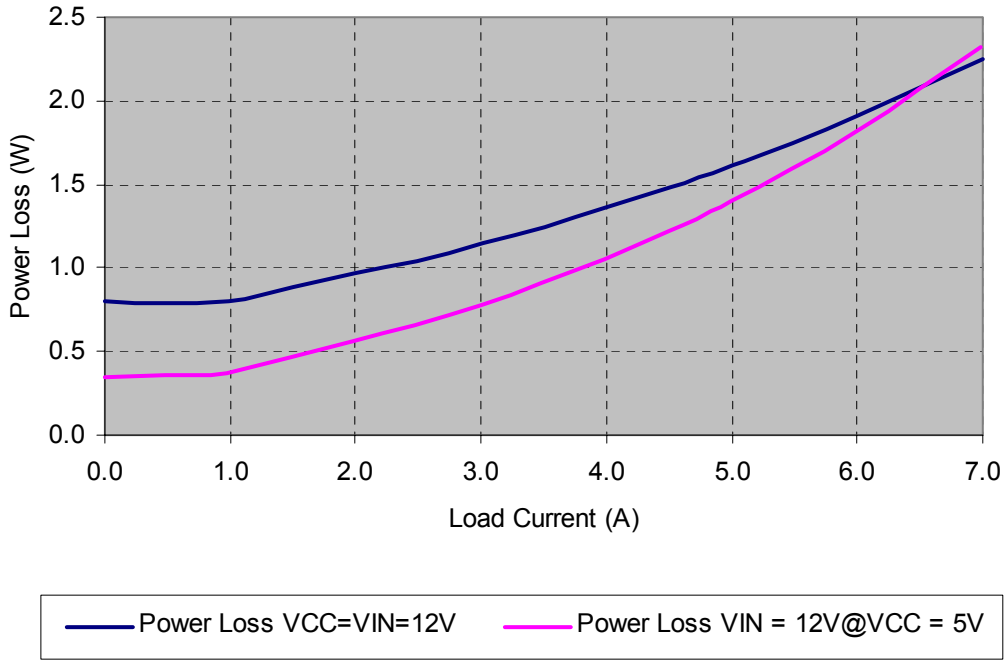


Fig.16: Power loss versus load current

THERMAL IMAGES
Vin=Vcc=12V, Vo=1.8V, Io=7A, Room Temperature, No Air Flow

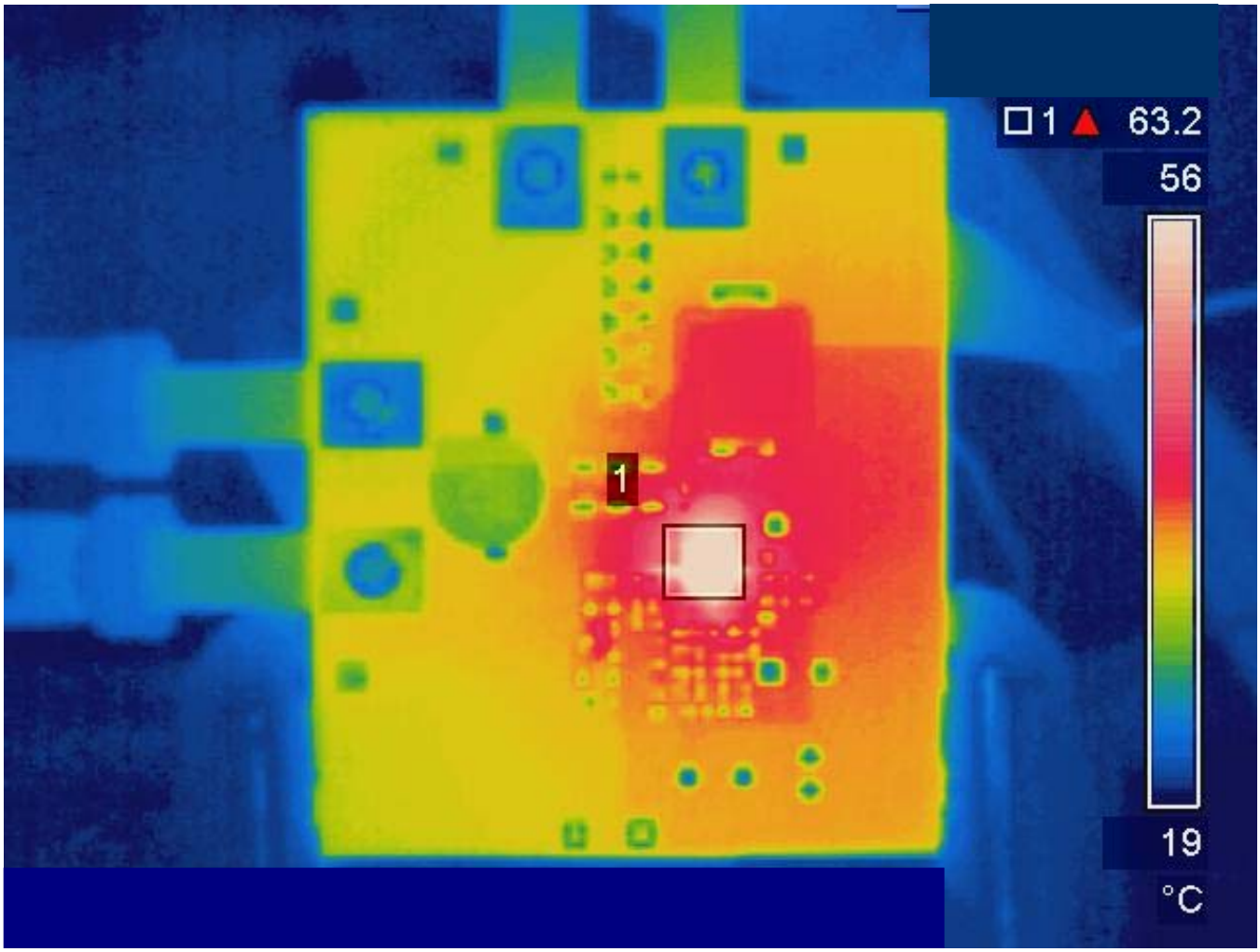


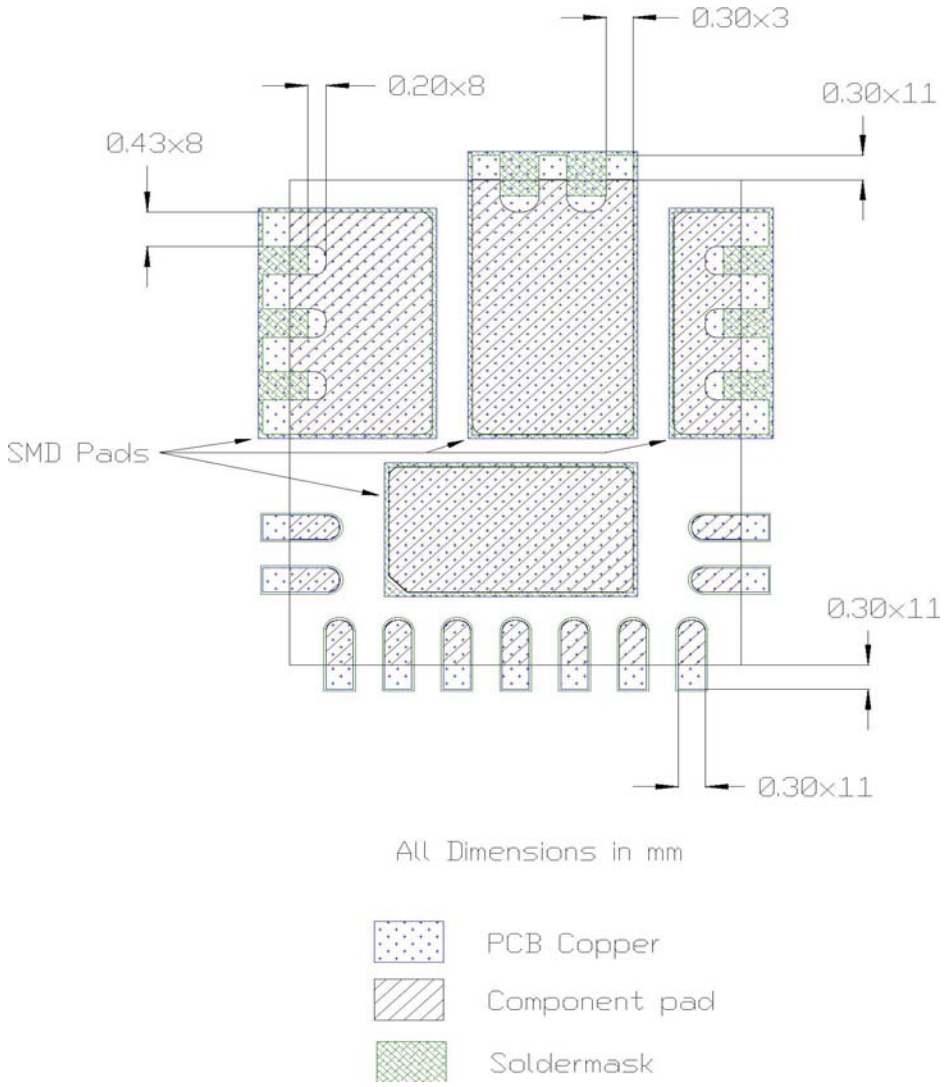
Fig. 17: Thermal Image at 7A load
Test point 1 is the IR3821

PCB Metal and Components Placement

The lead lands (the 11 IC pins) width should be equal to the nominal part lead width. The minimum lead to lead spacing should be ≥ 0.2mm to minimize shorting.

Lead land length should be equal to the maximum part lead length + 0.3 mm outboard extension. The outboard extension ensures a large and inspectable toe fillet.

The pad lands (the 4 big pads other than the 11 IC pins) length and width should be equal to maximum part pad length and width. However, the minimum metal to metal spacing should be no less than 0.17mm for 2 oz. Copper; no less than 0.1mm for 1 oz. Copper and no less than 0.23mm for 3 oz. Copper.

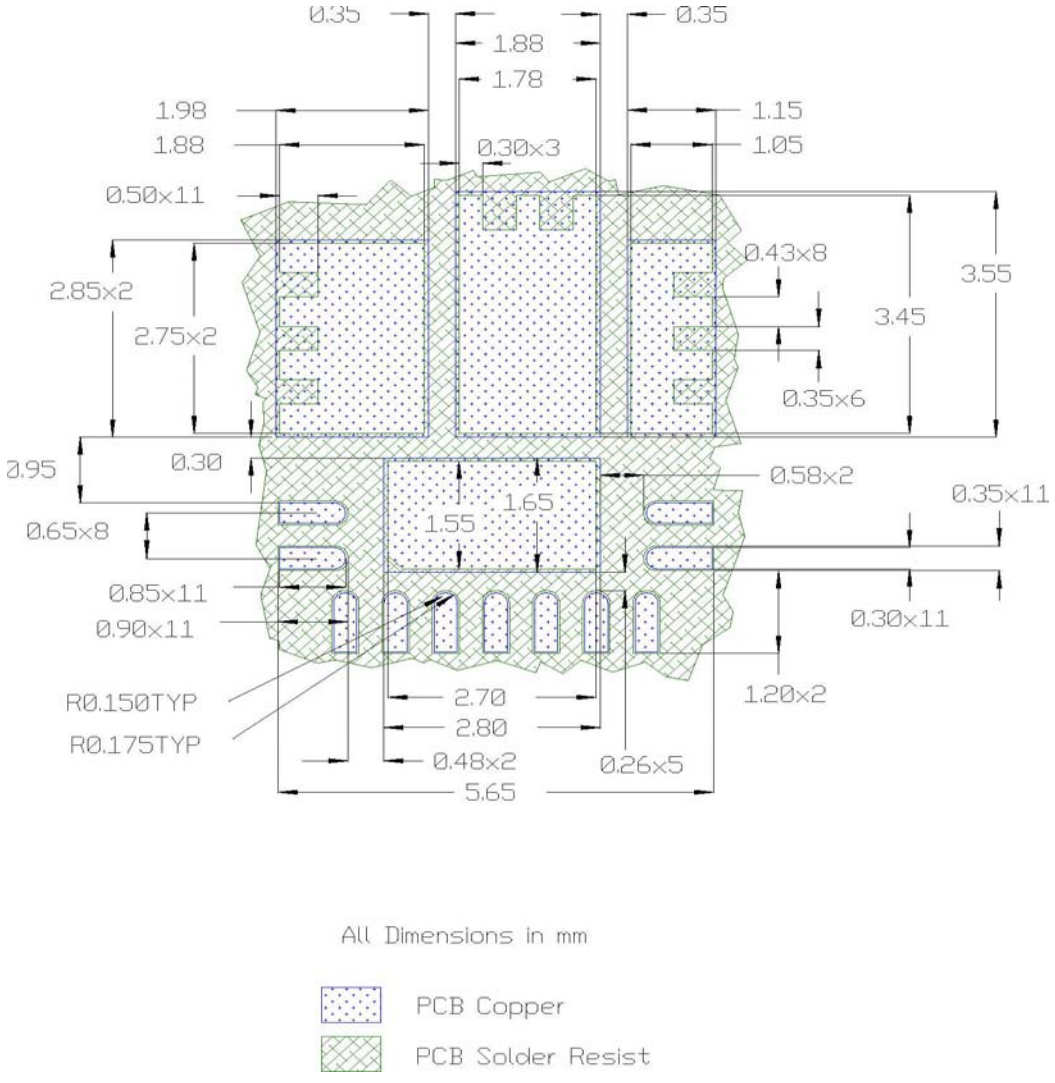


Solder Resist

It is recommended that the lead lands are Non Solder Mask Defined (NSMD). The solder resist should be pulled away from the metal lead lands by a minimum of 0.025mm to ensure NSMD pads.

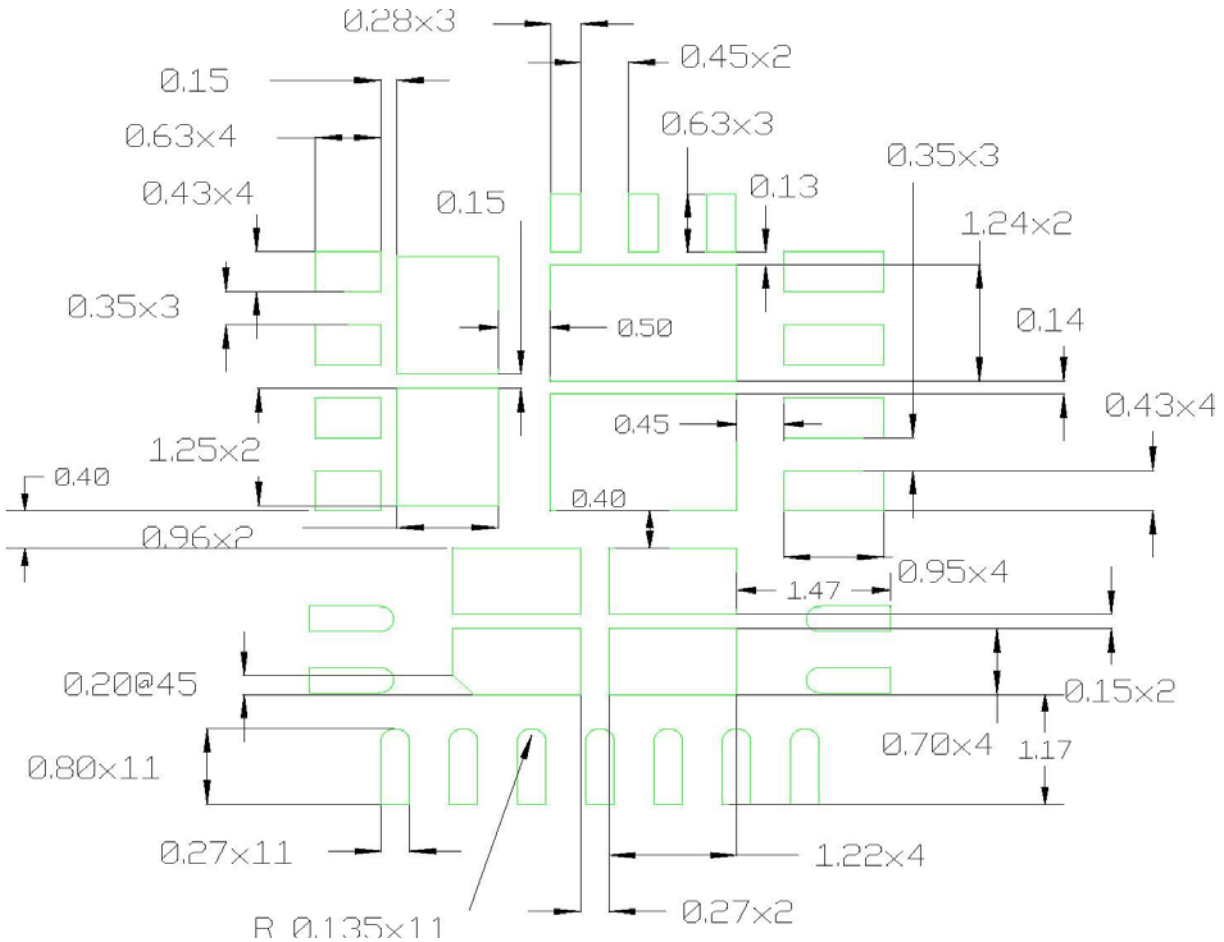
The land pad should be Solder Mask Defined (SMD), with a minimum overlap of the solder resist onto the copper of 0.05mm to accommodate solder resist mis-alignment.

Ensure that the solder resist in between the lead lands and the pad land is ≥ 0.15mm due to the high aspect ratio of the solder resist strip separating the lead lands from the pad land.

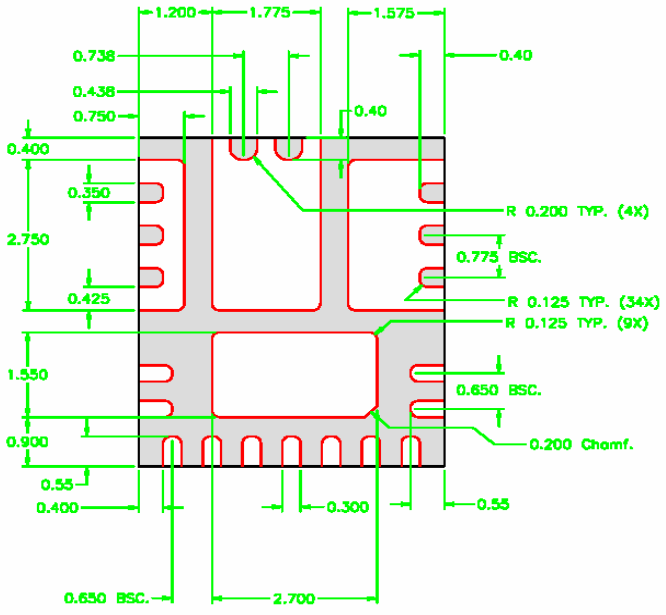


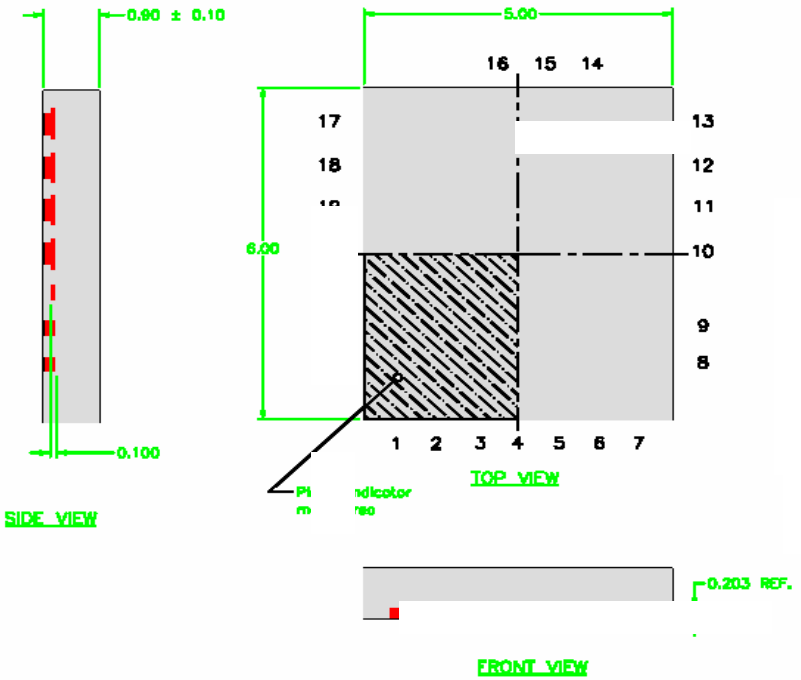
Stencil Design

- The Stencil apertures for the lead lands should be approximately 80% of the area of the lead lads. Reducing the amount of solder deposited will minimize the occurrences of lead shorts. If too much solder is deposited on the center pad the part will float and the lead lands will be open.
- The maximum length and width of the land pad stencil aperture should be equal to the solder resist opening minus an annular 0.2mm pull back to decrease the incidence of shorting the center land to the lead lands when the part is pushed into the solder paste.



Stencil Aperture
All Dimensions in mm





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Data and specifications subject to change without notice. 11/07